



Product Change Notification

Change Notification #: 118537-00
Change Title: Select Intel® NUC Rugged Chassis Element CMC1ABA, PCN 118537-00, Label, Product Marking Add NRTL logo on rating label and battery recycling mark on BOX label
Date of Publication: October 04, 2021

Key Characteristics of the Change:

Label, Product Marking

Forecasted Key Milestones:

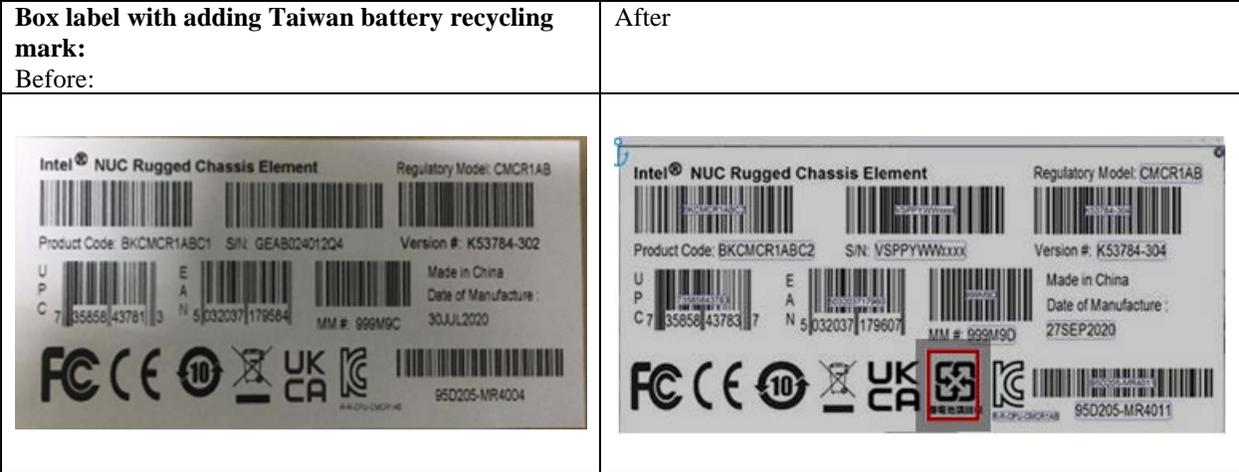
Date Customer Must be Ready to Receive Post-Conversion Material	November 01, 2021
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Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

1. Change CB logo on rating label from UL to NRTL due to Lab convert from UL CB to Nemko NRTL
2. Add Taiwan battery recycling mark on box label

Rating label with NTRL logo Before:	After:
<p>Intel® NUC Rugged Chassis Element Intel® NUC 電腦元件強固型套件 Intel® NUC 电脑元件加固形套件 INTEL CORPORATION</p> <p>Product code: 型號/型号/Regulatory Model: CMC1AB 直流輸入/直流輸入/Electrical Rating: 19V 4.74A 製造日期/制造日期/Date of Manufacture: 中國製造/中国制造/Made In China Board S/N:</p> <p>QR 9*9mm</p> <p>CAN ICES-3(B)/NMB-3(B) 使用前請仔細閱讀“用戶指南” 注意事項 使用前請仔細閱讀“用戶指南” 注意事項 Use only power supplies listed in the user instructions</p> <p>UK CA D33025 RoHS</p> <p>UL US E210882</p>	<p>Intel® NUC Rugged Chassis Element Intel® NUC 電腦元件強固型套件 Intel® NUC 电脑元件加固形套件 INTEL CORPORATION</p> <p>Product code: 型號/型号/Regulatory Model: CMC1AB 直流輸入/直流輸入/Electrical Rating: 19V 4.74A 製造日期/制造日期/Date of Manufacture: 中國製造/中国制造/Made In China Board S/N:</p> <p>QR 9*9mm</p> <p>CAN ICES-3(B)/NMB-3(B) 使用前請仔細閱讀“用戶指南” 注意事項 使用前請仔細閱讀“用戶指南” 注意事項 Use only power supplies listed in the user instructions</p> <p>UK CA D33025 RoHS</p> <p>NRTL US 206A00 62306</p>



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change SA	Post Change SA
Intel® NUC Rugged Chassis Element CMCR1ABA, no cord, 2 pack	BKCMCR1ABA	999M8V	K53776-205	K53776-206
Intel® NUC Rugged Chassis Element CMCR1ABA, US cord, 2 pack	BKCMCR1ABA1	999M93	K53776-205	K53776-206
Intel® NUC Rugged Chassis Element CMCR1ABA, EU cord, 2 pack	BKCMCR1ABA2	999M95	K53776-205	K53776-206

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 04, 2021	00	Originally Published PCN



Product Change Notification

118537-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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